

UCC1806 UCC2806 UCC3806

SLUS272C - FEBRUARY 2000 - REVISED JUNE 2003

LOW-POWER, DUAL-OUTPUT, CURRENT-MODE PWM CONTROLLER

FEATURES

- BiCMOS Version of UC3846 Family
- 1.4-mA Maximum Operating Current
- 100-μA Maximum Startup Current
- **●** ±0.5-A Peak Output Current
- 125-ns Circuit Delay
- Easier Parallelability
- Improved Benefits of Current Mode Control

DESCRIPTION

The UCC3806 family of BiCMOS PWM controllers offers exceptionally improved performance with a familiar architecture. With the same block diagram and pinout of the popular UC3846 series, the UCC3806 line features increased switching frequency capability while greatly reducing the bias current used within the device. With a typical startup current of 50 μ A and a well defined voltage threshold for turn-on, these devices are favored

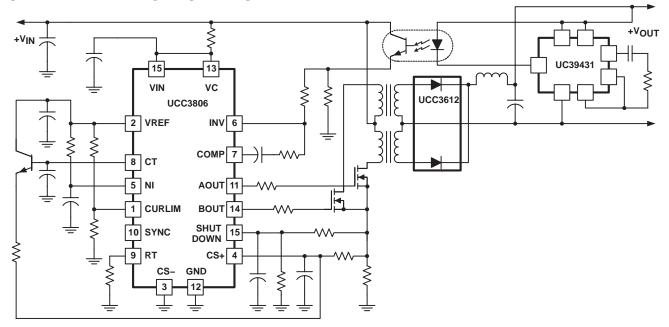
for applications ranging from off-line power supplies to battery operated portable equipment. Dual high-current, MOSFET driving outputs and a fast current sense loop further enhance device versatility.

All the benefits of current mode control including simpler loop closing, voltage feed-forward, parallelability with current sharing, pulse-by-pulse current limiting, and push/pull symmetry correction are readily achievable with the UCC3806 series.

These devices are available in multiple package options for both through-hole and surface mount applications; and in commercial, industrial, and military temperature ranges.

The UCC3806 is specified for operation from -55°C to 125°C, the UCC2806 is specified for operation from -40°C to 85°C, and the UCC3806 is specified for operation from 0°C to 70°C.

SIMPLIFIED APPLICATION DIAGRAM



TEXAS INSTRUMENTS www.ti.com



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted(1)

| | | UCx806 | UNIT | |
|---|-----------------------------|---------------------------------|------|--|
| Supply voltage, V _{IN} | VIN, low impedance | 15 | V | |
| Supply current, I _{IN} | VIN, high impedance | 25 | mA | |
| Output supply voltage | VC | 18 | V | |
| | Continuous source or sink | ± 200 | | |
| Output current | Gate drive | ± 500 | 1. | |
| | SYNC | ± 30 | mA | |
| | COMP | ± 10 to –(self-limiting) | 1 | |
| Analog input voltage range | CS-, CS+, NI, INV, SHUTDOWN | -0.3 to (V _{IN} + 0.3) | V | |
| Storage temperature, T _{Stg} | • | -65 to 150 | °C | |
| Operating temperature, TJ | -55 to 150 | °C | | |
| Lead temperature, T _{SOI} , 1,6 mm (1/16 i | 300 | °C | | |

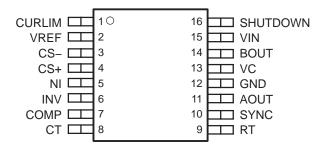
⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltages are with respect to GND. Currents are positive into and negative out of, the specified terminal.

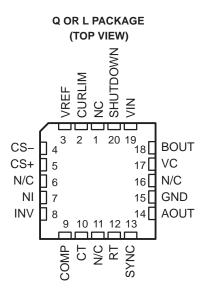
RECOMMENDED OPERATING CONDITIONS

| | | MIN | NOM | MAX | UNIT |
|------------------------------------|---------|-----|-----|------|------|
| Input voltage, V _{IN} | | 8.0 | | 14.5 | V |
| | UCC1806 | -55 | | 125 | |
| Operating junction temperature, TJ | UCC2806 | -40 | | 85 | °C |
| | UCC3806 | 0 | | 70 | |

PACKAGE DESCRIPTION

D, DW, J, M, N OR PW PACKAGE (TOP VIEW)





N/C - No connection



ORDERING INFORMATION

| | PACKAGED I | DEVICES | | T _A = T _J | | | |
|------------|------------|---------|----------|---------------------------------|----------------|-------------|--|
| DESIGNATOR | TYPE | OPTION | QUANTITY | – 55°C to 125°C | – 40°C to 85°C | 0°C to 70°C | |
| _ | 0010 40 | Tube | 40 | - | UCC2806D | - | |
| D | SOIC-16 | Reeled | 2,500 | _ | UCC2806DTR | _ | |
| DW | COLOW 40 | Tube | 40 | _ | UCC2806DW | UCC3806DW | |
| DW | SOICW-16 | Reeled | 2,000 | _ | UCC2806DWTR | UCC3806DWTR | |
| J | CDIP-16 | Tube | 25 | UCC1806J | UCC2806J | UCC3806J | |
| L | CLCC-20 | Tube | 55 | UCC1806L | - | _ | |
| М | SSOP-16 | Reeled | 2,500 | - | UCC2806MTR | - | |
| N | PDIP-16 | Tube | 25 | - | UCC2806N | UCC3806N | |
| 514/ | T000D 40 | Tube | 90 | - | UCC2806PW | UCC3806PW | |
| PW | TSSOP-16 | Reeled | 2,000 | - | UCC2806PWTR | UCC3806PWTR | |
| Q | DI 00 00 | Tube | 46 | _ | UCC2806Q | UCC3806Q | |
| | PLCC-20 | Reeled | 1,000 | _ | UCC2806QTR | UCC3806QTR | |

ELECTRICAL CHARACTERISTICS

 $V_{IN} = 12 \text{ V, R}_{T} = 33 \text{ k}\Omega, C_{T} = 330 \text{ pF, C}_{BYPASS} \text{ on V}_{REF} = 0.01 \text{ }\mu\text{F, } -55^{\circ}\text{C} < T_{A} < 125^{\circ}\text{C} \text{ for the UCC1806, } -40^{\circ}\text{C} < T_{A} < 85^{\circ}\text{C} \text{ for the UCC2806, } 0^{\circ}\text{C} < T_{A} < 70^{\circ}\text{C} \text{ for the UCC3806, and } T_{A} = T_{J} \text{ (unless otherwise noted)}$

| PARAMETER | | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------|-------------------------------|--------------------|---|------|------|------|------|
| REFEREN | CE | | | | | | |
| VREF | Supply, UVLO, turn-on | UCC1806 UCC2806 | | 5.02 | 5.10 | 5.17 | V |
| 1121 | | UCC3806 | | 5.00 | 5.10 | 5.20 | |
| | Load regulation | | 0.2 mA ≤ I _{OUT} ≤ 5 mA | | 3 | 25 | |
| | Total output variation (1)(2) | | Line, load, temperature | -150 | | 150 | mV |
| | Output noise voltage (2) | | 10 Hz \leq f _{OSC} \leq 10 kHz, $T_J = 25$ °C | | 70 | | μV |
| | Long term stability (2) | | T _A = 125°C, 1000 hours | | 5 | 25 | mV |
| | Output short circuit | | | -10 | | -30 | mA |
| OSCILLAT | OR | | | | | | |
| | Initial accuracy | | T _J = 25°C | 42 | 47 | 52 | kHz |
| | Temperature stability (2) | | $T(min) \le T_A \le T(max)$ | | 2% | | |
| | Amplitude | | | | 2.35 | | V |
| | Delevis esterilis OVAIO | UCC1806 UCC2806 | $V_{CT} = 0 \text{ V}, \qquad V_{RT} = V_{REF}$ $0.8 \text{ V} \le V_{SYNC} \le 2.0 \text{ V}$ | | 50 | 125 | |
| ^t DELAY | Delay-to-output time, SYNC | UCC3806 | $V_{CT} = 0 \text{ V},$ $V_{RT} = V_{REF}$ $0.8 \text{ V} \le V_{SYNC} \le 2.0 \text{ V}$ | | 50 | 100 | ns |



ELECTRICAL CHARACTERISTICS

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| | PARAMETER | | TEST CO | ONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|---|--------------------|--|--|------|------|--------------------|------|
| OSCILLATO | R (continued) | | | | | | | |
| IDCHG | Discharge current | | T _J = 25°C, | V _{CT} = 2.0 V | | 2 | | mA |
| VOL | Low-level output voltage, SYN | VC . | I _{OUT} = 1 mA | | | | 0.4 | |
| Vон | High-level output voltage, SYNC | | I _{OUT} = -4 mA | | 2.4 | | | |
| V _{IL} | Low-level input voltage, SYN | С | V _{CT} = 0 V, | V _{RT} = V _{REF} | | | 0.8 | V |
| VIH | High-level input voltage, SYN | С | V _{CT} = 0 V, | V _{RT} = V _{REF} | 2.0 | | | |
| ISYNC | Input current, SYNC | | | | -1 | | 1 | μΑ |
| ERROR AME | PLIFIER | | | | | | | |
| | Input offset voltage | UCC1806 UCC2806 | | | | | 5 | mV |
| | | UCC3806 | | | | | 10 | |
| I _{BIAS} | Input bias current | | | | | | -1 | μΑ |
| IOFSET | Input offset current | | | | | | 500 | nA |
| CMR | Common mode range(1) | | | | 0 | | V _{IN} -2 | V |
| A _{VOL} | Open loop gain | | 1 V ≤ V _{OUT} ≤ 4 V | | 80 | 100 | | dB |
| GBW | bandwidth | | | | 1 | | | MHz |
| COMP_SINK | Output sink current | | V _{ID} < −20 mV, | V _{COMP} = 1 V | 1 | | | mA |
| ICOMP_SRC | Output source current | | V _{ID} < 20 mV, | V _{COMP} = 3 V | -80 | -120 | | μΑ |
| VCOMP_L | Low-level output voltage | | $V_{ID} = -50 \text{ mV}$ | | | | 0.5 | ., |
| VCOMP_H | High-level output voltage | | $V_{ID} = -50 \text{ mV}$ | | 4.5 | | | V |
| CURRENT S | ENSE AMPLIFIER | | • | | - | | | |
| Α | Amplifier gain(3)(4) | | $V_{CS-} = 0 V$, | VCURLIM = VREF | 2.75 | 3.00 | 3.35 | V/V |
| | Maximum differential input sig – V _{CS} –) | nal (VCS+ | VCURLIM = VNI = VINV = 0V | VREF, | 1.1 | | | V |
| | Input offset voltage | UCC1806 UCC2806 | V _{CURLIM} = 0.5 V, | V _{COMP} = OPEN | | 10 | 30 | μΑ |
| | , | UCC3806 | V _{CURLIM} = 0.5 V, | V _{COMP} = OPEN | | 10 | 50 | mV |
| CMRR | Common mode rejection ratio |) | $0 \text{ V} \leq \text{V}_{CM} \leq (\text{V}_{IN} - \text{V}_{IN})$ | - 3.5 V) | 60 | | | dB |
| PSRR | Power supply rejection ratio | | | | 56 | | | dB |
| IBIAS | Input bias current (3) | | V _{CURLIM} = 0.5 V, | V _{COMP} = OPEN | | | -1 | μΑ |
| | Input offset current (3) | | V _{CURLIM} = 0.5 V, | V _{COMP} = OPEN | | | 1 | μΑ |
| | Delay-to-output time (5) | | V _{NI} = V _{REF} , V _{CURLIM} = 2.75 V (V _{CS+} - V _{CS-}) = | V _{INV} = 0 V, 0 V to 1.5 V step | | 125 | 175 | ns |
| CURRENT L | IMIT ADJUST | | | | | | | |
| | Current limit offset | | $V_{CS-} = V_{CS+} = 0$ | V,V _{COMP} = OPEN | 0.4 | 0.5 | 0.6 | V |
| I _{BIAS} | Input bias current | | | | | | 1 | |
| | Minimum latching current | | | | 300 | 200 | | μΑ |
| | Maximum non-latching currer | nt | | | | 200 | 80 | |

 ⁽¹⁾ Line range = 10 V to 15 V, load range = 0.2 mA to 5 mA
 (2) Ensured by design. Not production tested.



ELECTRICAL CHARACTERISTICS

 $V_{IN} = 12 \text{ V, R}_{T} = 33 \text{ k}\Omega, C_{T} = 330 \text{ pF, C}_{BYPASS} \text{ on V}_{REF} = 0.01 \text{ }\mu\text{F, } -55^{\circ}\text{C} \text{ to } 125^{\circ}\text{C} \text{ for the UCC1806, } -40^{\circ}\text{C} < T_{A} < 85^{\circ}\text{C} \text{ for the UCC2806, } 0^{\circ}\text{C} < T_{A} < 70^{\circ}\text{C} \text{ for the UCC3806, and } T_{A} = T_{J} \text{ (unless otherwise noted)}$

| SHUTDO | OWN TERMINAL | | | | | | | |
|-------------------|-------------------------------|--------------------|--------------------------------------|-----------------------------|------|------|------|----|
| | Threshold voltage | UCC1806 UCC2806 | | | 0.94 | 1.00 | 1.06 | |
| | · · | UCC3806 | | | 0.9 | 1.0 | 1.1 | V |
| | Input voltage range | | | | 0 | | VIN | |
| tDLY | Delay-to-output time | | 0 V ≤ VSHUTDO | OWN ≤ 1.3 V | | 75 | 150 | ns |
| OUTPUT | Г | | | | | | | |
| | Output supply voltage | | | | 2.5 | | 15.0 | |
| | | UCC1806 | I _{SINK} = 20 mA | | | 100 | 300 | |
| | Landard administration | UCC2806 | I _{SINK} = 100 mA | | | 0.4 | 1.1 | |
| | Low-level output voltage | UCC3806 | I _{SINK} = 20 mA | | | 100 | 200 | V |
| | | | I _{SINK} = 100 mA | | | 0.4 | 1.1 | |
| | | | $I_{SRC} = -20 \text{ mA}$ | | 11.6 | 11.9 | | |
| | High-level output voltage | | ISRC = -100 m/ | 4 | 11.0 | 11.6 | | |
| ^t RISE | Rise time | | T _J = 25°C, | C _{LOAD} = 1000 pF | | 35 | 65 | |
| tFALL | Fall time | | T _J = 25°C, | C _{LOAD} = 1000 pF | | 35 | 65 | ns |
| UNDER | VOLTAGE LOCKOUT (UVLO) | | | | | | | |
| VSTART | Startup threshold voltage | | | | 6.5 | 7.5 | 8.0 | V |
| | Threshold hysteresis | | | | | 0.75 | | V |
| ISTART | - Startup current | | V _{IN} < V _{START} | | | 50 | 100 | μΑ |
| I | Operating supply current | | | | | 1.0 | 1.4 | mA |
| | V _{IN} shunt voltage | | I _{VIN} = 10 mA | | 15.0 | | 17.5 | |

- (1) Line range = 10 V to 15 V, load range = 0.2 mA to 5 mA
- (2) Ensured by design. Not production tested.
- (3) Parameters measured at trip point of latch with $V_{NI} = VREF$, $V_{INV} = 0V$.
- (4) Amplifier gain defined as: G = delta change at COMP /delta change forced at CS+ delta voltage at CS+ = 0 to 1V
- (5) Current-sense amplifier output is slew rate limited to provide noise immunity.

THERMAL RESISTANCE TABLE

| PACKAGE DESIGNATOR | PACKAGE TYPE | (°C/W) | θJA (°C/W) |
|-----------------------|--------------|--------|---------------------------|
| D | SOIC-16 | 35 | 50 to 120 ⁽¹⁾ |
| DW | SOICW-16 | 27 | 50 to 100 ⁽¹⁾ |
| J | CDIP-16 | 28 | 80 to 120 |
| L | CLCC-20 | 20 | 70 to 80 |
| M | SSOP-16 | 38 | 144 to 172 ⁽²⁾ |
| N | PDIP-16 | 45 | 90(1) |
| PW | TSSOP-16 | 15 | 123 to 147 ⁽²⁾ |
| Q | PLCC-20 | 34 | 43 to 75(1) |

⁽¹⁾ Specified θ JA (junction to ambient) is for devices mounted to 5 in² FR4 PC board with one ounce copper where noted. When resistance range is given, lower values are for 5 in² aluminum PC board. Test PWB was 0.062 in thick and typically used 0.635 mm trace widths for power packages and 1.3 mm trace widths for non-power packages with a 100x100 mil probe land area at the end of each trace.

⁽²⁾ Modeled data. If value range given for θ JA, the lower value is for 3x3 inch1 oz internal copper ground plane, and the higher value is for 1x1 inch ground plane. All model data assumes only one trace for each non-fused lead.



5

TERMINAL FUNCTIONS

| - | TERMINAL | | | |
|----------|-------------------|------|-----|--|
| | PACK | AGES | 1/0 | DESCRIPTION |
| NAME | D/DW/J/M /N/PW | L,Q | .,0 | DESCRIPTION |
| AOUT | 11 | 14 | | III I I I I I I I I I I I I I I I I I |
| BOUT | 14 | 18 | 0 | High-current gate drive for the external MOSFETs |
| COMP | 7 | 9 | 0 | Output of the error amplifier |
| CS- | 3 | 4 | I | Inverting input of the 3x, differential current sense amplifier |
| CS+ | 4 | 5 | I | Non-inverting input of the 3×, differential current sense amplifier |
| СТ | 8 | 10 | I | Oscillator timing capacitor connection point |
| CURLIM | 1 | 2 | I | Programs the primary current limit threshold that determins latching or retry after an overcurrent situation |
| GND | 12 | 15 | _ | Reference ground and power ground for all functions of this device |
| INV | 6 | 8 | I | Inverting input of the error amplifier. |
| NI | 5 | 7 | I | Non-nverting input of the error amplifier. |
| RT | 9 | 12 | I | Connection point for the oscillator timing resistor |
| SHUTDOWN | 16 | 20 | I | Provided for enhanced protection. When SHUTDOWN is driven above 1 V, AOUT and BOUT are forced low. |
| SYNC | 10 | 13 | I/O | Allows providing external synchronization with TTL compatible thresholds. |
| VC | 13 | 17 | I | Input supply connection for the FET drive outputs. |
| VIN | 15 | 19 | I | Input supply connection for this device. |
| VREF | 2 | 3 | 0 | Reference output. |

DETAILED PIN DESCRIPTIONS

AOUT and BOUT: AOUT and BOUT provide alternating high current gate drive for the external MOSFETs. Duty cycle can be varied from 0% to 50% where minimum dead time is a function of CT. Both outputs use MOS transistor switches with inherent anti-parallel body diodes to clamp voltage swings to the supply rails, allowing operation without the use of clamp diodes.

COMP: COMP is the output of the error amplifier and the input of the PWM comparator. The error amplifier is a low output impedance, 2-MHz operational amplifier which allows sinking or sourcing of current at the COMP pin. The error amplifier is internally current limited, so that zero duty cycle can be commanded by externally forcing COMP to GND.

CS-: CS- is the inverting input of the 3× differential current sense amplifier.

CS+: CS+ is the non-inverting input of the 3× differential current sense amplifier.

CT: CT is the oscillator timing capacitor connection point, which is charged by the current set by RT. CT is discharged to GND through a 2.6-mA current sink. This causes a linear discharge of CT to 0 V which then initiates the next switching cycle. Dead time occurs during the discharge of CT, forcing AOUT and BOUT low. Switching frequency (f_S) and dead time (t_D) are approximated by:

$$f_{S} = \frac{1}{2 \times R_{T} \times C_{T} + t_{D}}$$
 and $t_{D} = 961 \times C_{T}$ (1)



DETAILED PIN DESCRIPTIONS (continued)

CURLIM: CURLIM programs the primary current limit threshold and determines whether the device latches off or retries after an overcurrent condition. When a shutdown signal is generated, a 200- μ A current source to ground pulls down on CURLIM. If the voltage on the pin remains above 350 mV the device remains latched and the power must be cycled to restart. If the voltage on the pin falls below 350 mV, the device attempts a restart. The voltage threshold is typically set by a resistor divider from V_{REF} to ground. To calculate the current limit adjust voltage threshold the following equations can be used.

Current limit adjust latching mode voltage is calculated in equation (2)

$$V = \frac{V_{REF} - (R1 \times 300 \,\mu\text{A} \times 3)}{1 + \left(\frac{R1}{R2}\right)} > 350 \,\text{mV}$$
(2)

Current limit adjust non-latching mode voltage is calculated in equation (3)

$$V = \frac{V_{REF} - (R1 \times 80 \,\mu\text{A} \times 3)}{1 + \left(\frac{R1}{R2}\right)} < 350 \,\text{mV} \tag{3}$$

where

- R1 is the resistance from the VREF to CURLIM
- R2 is the resistance from CURLIM to GND

GND: GND is the reference ground and power ground for all functions of this part. Bypass and timing capacitors should be connected as close as possible to GND.

RT: RT is the connection point for the oscillator timing resistor. It has a low impedance input and is nominally at 1.25 V. The current through RT is mirrored to the timing capacitor pin, CT. This causes a linear charging of CT from 0 V to 2.35 V. Note that the current mirror is limited to a maximum of 100 μ A so R_T must be greater than 12.5 k Ω .

SYNC: SYNC is a bi-directional pin, allowing or providing external synchronization with TTL compatible thresholds. In a typical application RT is connected through a timing resistor to GND which allows the internal oscillator to free run. In this mode SYNC outputs a TTL compatible pulse during the oscillator dead time (when CT is being discharged). If RT is forced above 4.4 V, SYNC acts as an input with TTL compatible thresholds and the internal oscillator is disabled. When SYNC is high, greater than 2 V the outputs are held active low. When SYNC returns low, the outputs may be high until the on–time is terminated by the normal peak current signal, a fault seen at SHUTDOWN or the next high assertion of SYNC. Multiple UCC3806s can be synchronized by a single master UCC3806 or external clock.

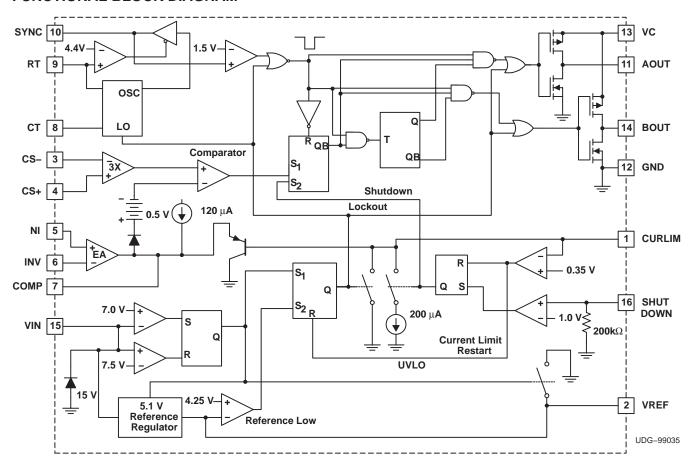
VC: VC is the input supply connection for the FET drive outputs and has an input range from 2.5 V to 15 V. VC should be capacitively bypassed for proper operation.

VIN: VIN is the input supply connection for this device. The UCC1806 has a maximum startup threshold of 8 V and internally limited by means of a 15 V shunt regulator. The shunted supply current must be limited to 2.5 mA. For proper operation, VIN must be bypassed to GND with at least a 0.01-μF ceramic capacitor

VREF: VREF is a 5.1 V $\pm 1\%$ trimmed reference output with a 5 mA maximum available current. VREF must be bypassed to GND with at least a 0.1- μ F ceramic capacitor for proper operation.

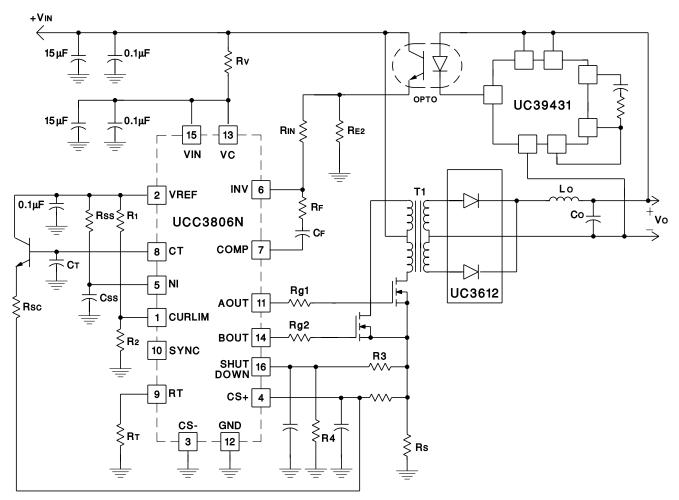


FUNCTIONAL BLOCK DIAGRAM





TYPICAL APPLICATION DIAGRAM



UDG-99036

TYPICAL CHARACTERISTICS

Design equations for oscillator are described in the following equations.

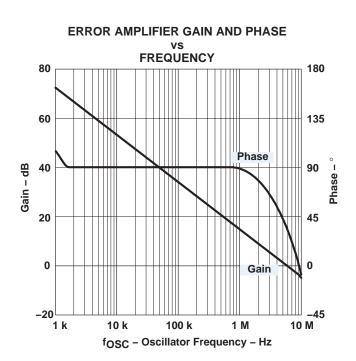
$$f_{\rm OSC} = \frac{1}{t_{\rm RAMP} + t_{\rm FALL}} \tag{4}$$

$$t_{RAMP} = 1.92 \times R_{T} \times C_{T} \tag{5}$$

$$t_{\text{FALL}} = \frac{2.4 \times C_{\text{T}}}{\left(0.002 - \left(\frac{1.25}{R_{\text{T}}}\right)\right)} \tag{6}$$

$$t_{\mathsf{DEAD}} = t_{\mathsf{FALL}} \tag{7}$$

TYPICAL CHARACTERISTICS



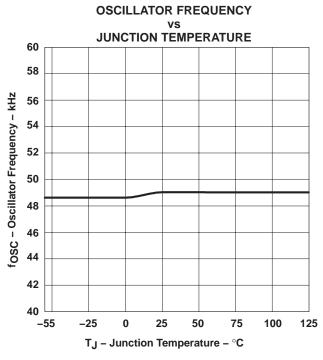
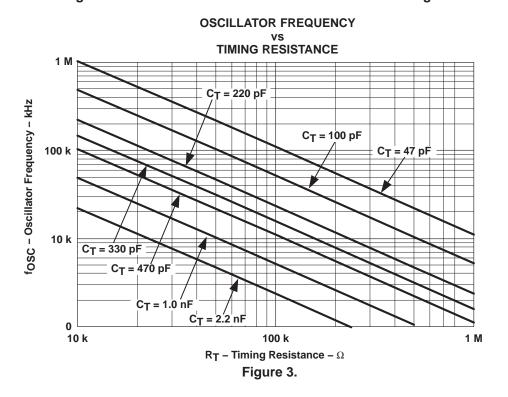


Figure 1.

Figure 2.











PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| 5962-9457501MEA | ACTIVE | CDIP | J | 16 | 1 | None | A42 SNPB | Level-NC-NC-NC |
| 5962-9457501Q2A | ACTIVE | LCCC | FK | 20 | 1 | None | POST-PLATE | Level-NC-NC-NC |
| 5962-9457501V2A | ACTIVE | LCCC | FK | 20 | 1 | None | Call TI | Level-NC-NC-NC |
| 5962-9457501VEA | ACTIVE | CDIP | J | 16 | 1 | None | Call TI | Level-NC-NC-NC |
| UCC1806J | ACTIVE | CDIP | J | 16 | 1 | None | A42 SNPB | Level-NC-NC-NC |
| UCC1806J883B | ACTIVE | CDIP | J | 16 | 1 | None | A42 SNPB | Level-NC-NC-NC |
| UCC1806JQMLV | ACTIVE | CDIP | J | 16 | | None | Call TI | Call TI |
| UCC1806L | ACTIVE | LCCC | FK | 20 | 1 | None | POST-PLATE | Level-NC-NC-NC |
| UCC1806L883B | ACTIVE | LCCC | FK | 20 | 1 | None | POST-PLATE | Level-NC-NC-NC |
| UCC1806LQMLV | ACTIVE | LCCC | FK | 20 | | None | Call TI | Call TI |
| UCC2806D | ACTIVE | SOIC | D | 16 | 40 | None | CU NIPDAU | Level-1-220C-UNLIM |
| UCC2806DTR | ACTIVE | SOIC | D | 16 | 2500 | None | CU NIPDAU | Level-1-220C-UNLIM |
| UCC2806DW | ACTIVE | SOIC | DW | 16 | 40 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806DWTR | ACTIVE | SOIC | DW | 16 | 2000 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806J | ACTIVE | CDIP | J | 16 | 1 | None | A42 SNPB | Level-NC-NC-NC |
| UCC2806M | ACTIVE | SSOP/ QSOP | DBQ | 16 | 75 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806MTR | ACTIVE | SSOP/ QSOP | DBQ | 16 | 2500 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806N | ACTIVE | PDIP | N | 16 | 25 | None | CU SNPB | Level-NA-NA-NA |
| UCC2806PW | ACTIVE | TSSOP | PW | 16 | 90 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806PWTR | ACTIVE | TSSOP | PW | 16 | 2000 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC2806PWTRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| UCC2806Q | ACTIVE | PLCC | FN | 20 | 46 | None | CU SNPB | Level-2-220C-1 YEAR |
| UCC2806QTR | ACTIVE | PLCC | FN | 20 | 1000 | None | CU SNPB | Level-2-220C-1 YEAR |
| UCC3806DW | ACTIVE | SOIC | DW | 16 | 40 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC3806DWTR | ACTIVE | SOIC | DW | 16 | 2000 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC3806J | ACTIVE | CDIP | J | 16 | 1 | None | A42 SNPB | Level-NC-NC-NC |
| UCC3806N | ACTIVE | PDIP | N | 16 | 25 | None | CU SNPB | Level-NA-NA-NA |
| UCC3806PW | ACTIVE | TSSOP | PW | 16 | 90 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC3806PWTR | ACTIVE | TSSOP | PW | 16 | 2000 | None | CU NIPDAU | Level-2-220C-1 YEAR |
| UCC3806Q | ACTIVE | PLCC | FN | 20 | 46 | None | CU SNPB | Level-2-220C-1 YEAR |
| UCC3806QTR | ACTIVE | PLCC | FN | 20 | 1000 | None | CU SNPB | Level-2-220C-1 YEAR |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

8-Mar-2005

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

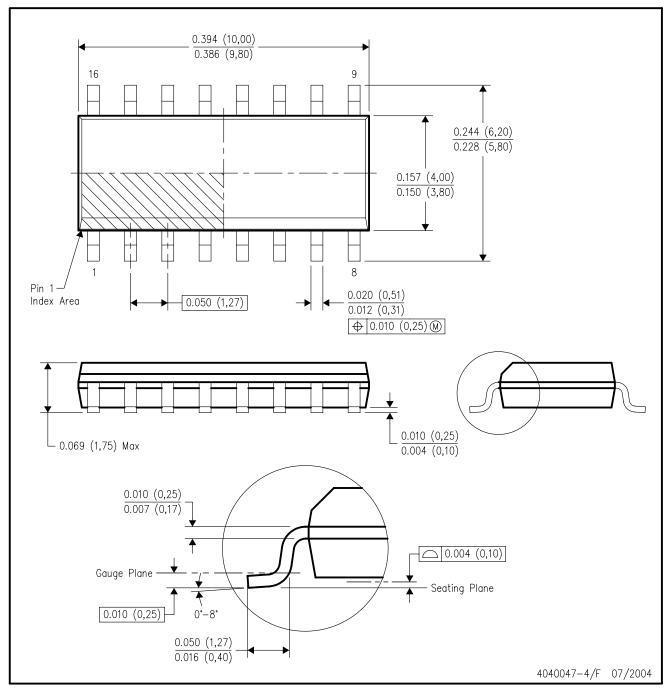


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



FN (S-PQCC-J**)

20 PIN SHOWN

PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-018



DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE

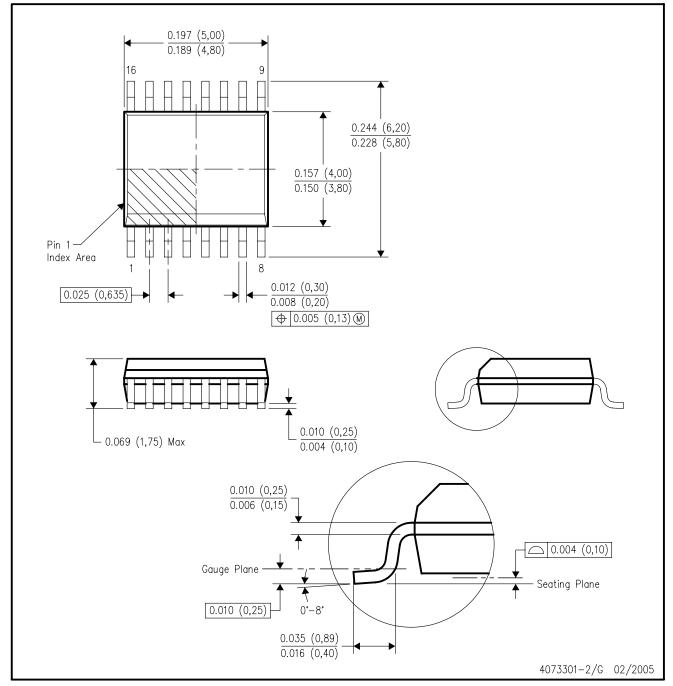


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.



DBQ (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15) per side.
- D. Falls within JEDEC MO-137 variation AB.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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